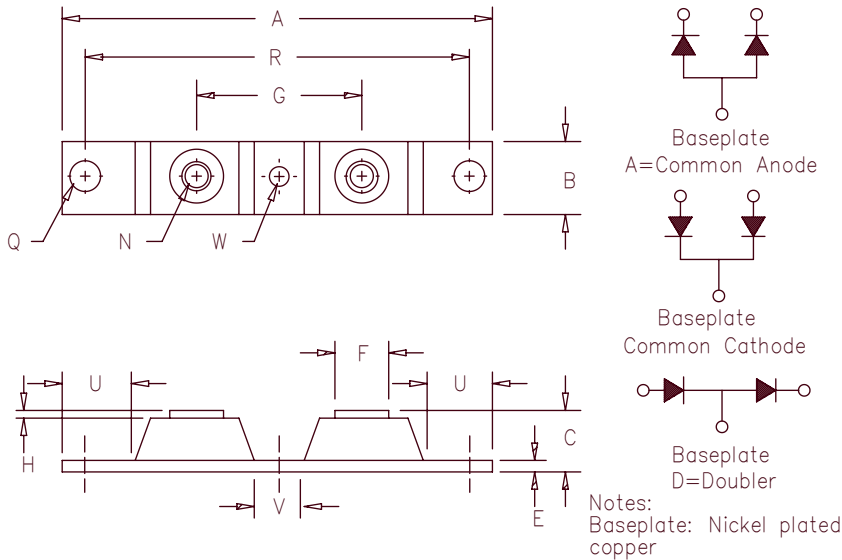


# Ultrafast Recovery Modules UFT200, 201 & 202



Dim.	Inches		Millimeters		Notes
	Min.	Max.	Min.	Max.	
A	---	3.630	---	92.20	
B	0.700	0.800	17.78	20.32	
C	---	0.630	---	16.00	
E	0.120	0.130	3.05	3.30	
F	0.490	0.510	12.45	12.95	
G	1.375 BSC		34.92 BSC		
H	0.010	---	0.25	---	
N	---	---	---	---	1/4-20
Q	0.275	0.290	6.99	7.37	Dia.
R	3.150 BSC		80.01 BSC		
U	0.600	---	15.24	---	
V	0.312	0.340	7.92	8.64	
W	0.180	0.195	4.57	4.95	Dia.

Microsemi Catalog Number	Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
UFT20005*	50V	50V
UFT20010*	100V	100V
UFT20015*	150V	150V
UFT20020*	200V	200V
UFT20120*	200V	200V
UFT20130*	300V	300V
UFT20140*	400V	400V
UFT20150*	500V	500V
UFT20260*	600V	600V
UFT20270*	700V	700V
UFT20280*	800V	800V

Add Suffix A for Common Anode, D for Doubler

- Ultra Fast Recovery
- 175°C Junction Temperature
- $V_{RRM}$  50 to 800 Volts
- High surge capacity
- 2 X 100 Amp current rating
- ROHS Compliant

## Electrical Characteristics

		UFT200	UFT201	UFT202	
Average forward current per pkg	$I_F(AV)$	200A	200A	200A	Square Wave
Average forward current per leg	$I_F(AV)$	100A	100A	100A	Square Wave
Case Temperature	TC	135°C	120°C	115°C	$R_{\theta JC} = 0.5^\circ C/W$
Maximum surge current per leg	$I_{FSM}$	1500A	1400A	1200A	8.3ms, half sine, $T_J = 175^\circ C$
Max peak forward voltage per leg	$V_{FM}$	.975V	1.25V	1.35V	$I_{FM} = 100A; T_J = 25^\circ C^*$
Max reverse recovery time per leg	$t_{rr}$	50ns	70ns	90ns	1/2A, 1A, 1/4A, $T_J = 25^\circ C$
Max peak reverse current per leg	$I_{RM}$	---	6.0mA	---	$V_{RRM}, T_J = 125^\circ C$
Max peak reverse current per leg	$I_{RM}$	---	50μA	---	$V_{RRM}, T_J = 25^\circ C$
Typical Junction capacitance	$C_J$	575pF	300pF	275pF	$V_R = 10V, T_J = 25^\circ C$

\*Pulse test: Pulse width 300μsec, Duty cycle 2%

## Thermal and Mechanical Characteristics

Storage temp range	$T_{STG}$	-55°C to 175°C
Operating junction temp range	$T_J$	-55°C to 175°C
Max thermal resistance per leg	$R_{\theta JC}$	0.5°C/W Junction to case
Max thermal resistance per pkg	$R_{\theta JC}$	0.25°C/W Junction to case
Typical thermal resistance	$R_{\theta CS}$	0.08°C/W Case to sink
Terminal Torque		35-50 inch pounds
Mounting base torque - (outside holes)		30-40 inch pounds
Mounting base torque - (center hole)		8-10 inch pounds
center bolt must be torqued first		
Weight		2.8 ounces (75 grams) typical

# UFT200

Figure 1  
Typical Forward Characteristics – Per Leg

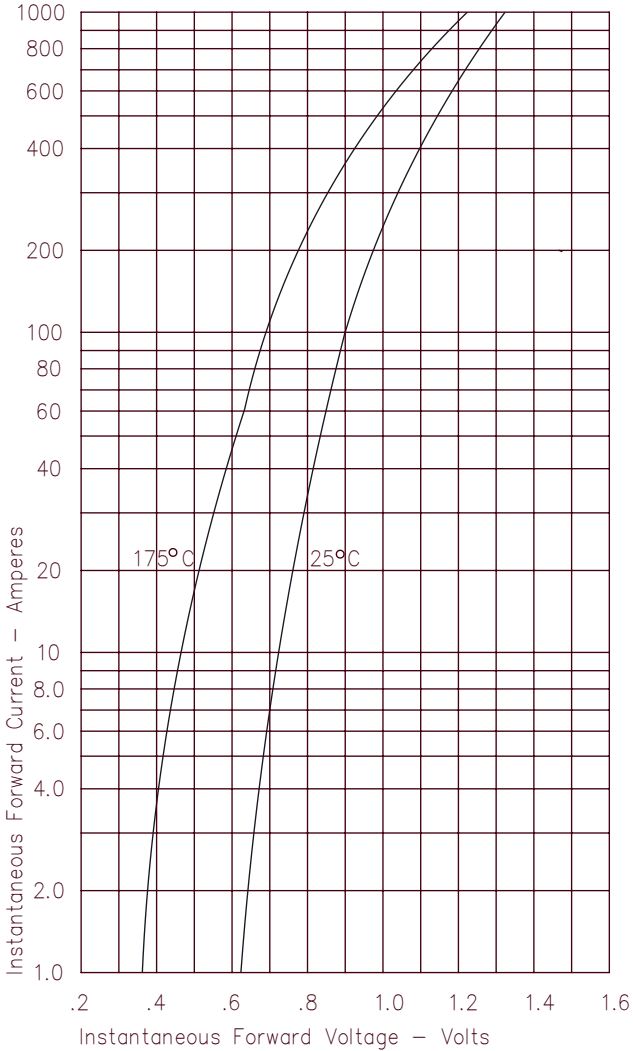


Figure 3  
Typical Junction Capacitance – Per Leg

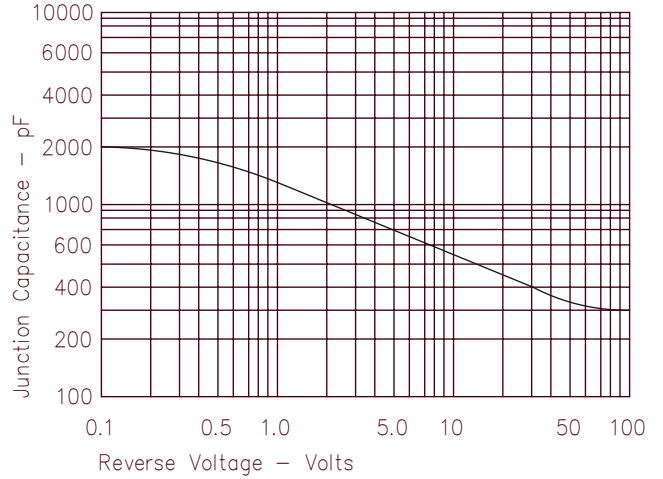


Figure 4  
Forward Current Derating – Per Leg

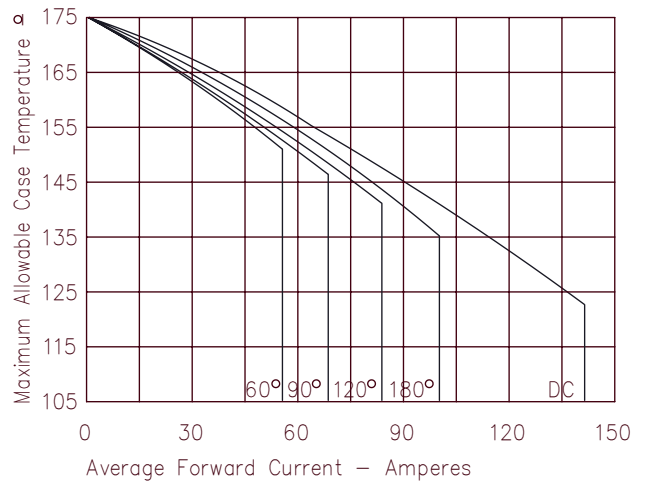


Figure 2  
Typical Reverse Characteristics – Per Leg

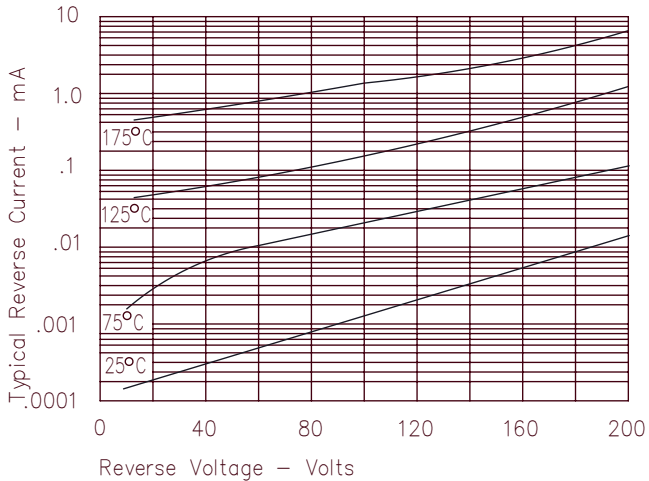
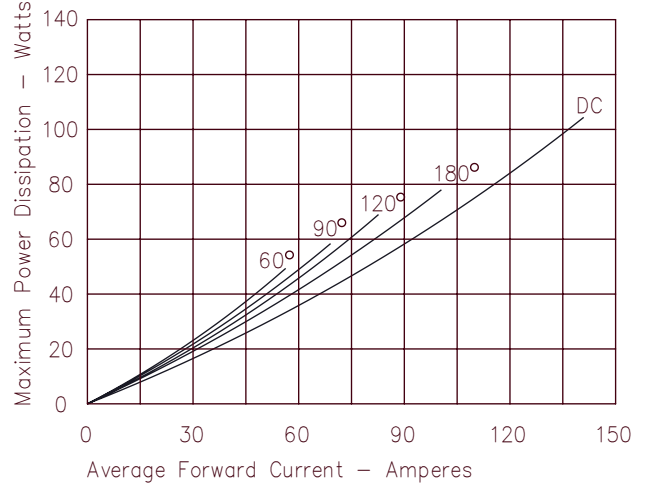


Figure 5  
Maximum Forward Power Dissipation – Per Leg



# UFT201

Figure 1  
Typical Forward Characteristics – Per Leg

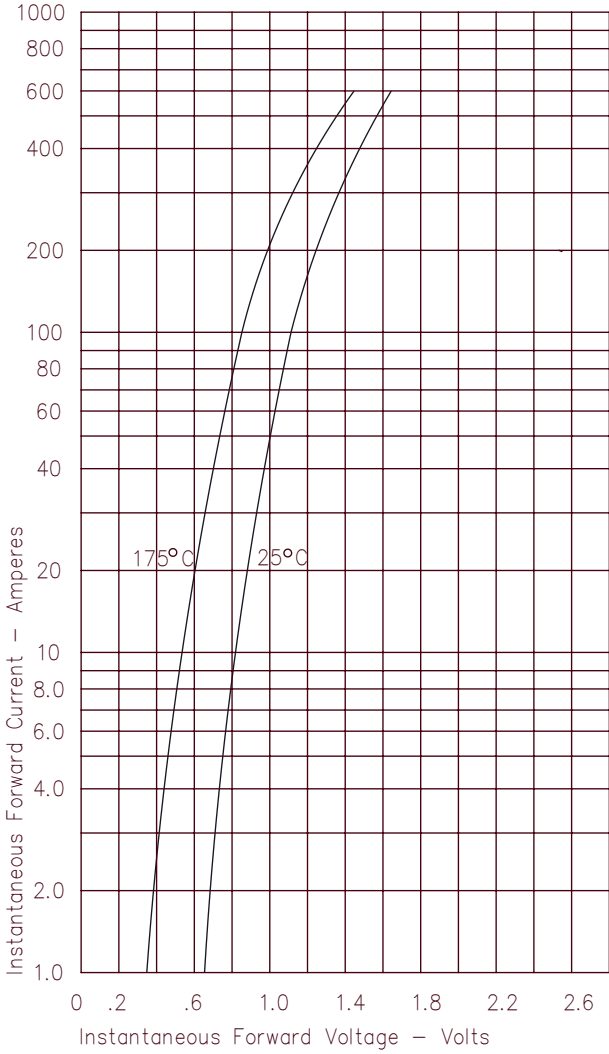


Figure 3  
Typical Junction Capacitance – Per Leg

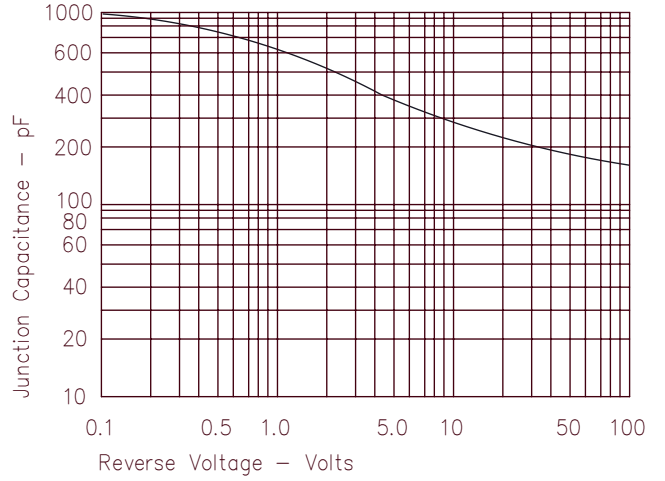


Figure 4  
Forward Current Derating – Per Leg

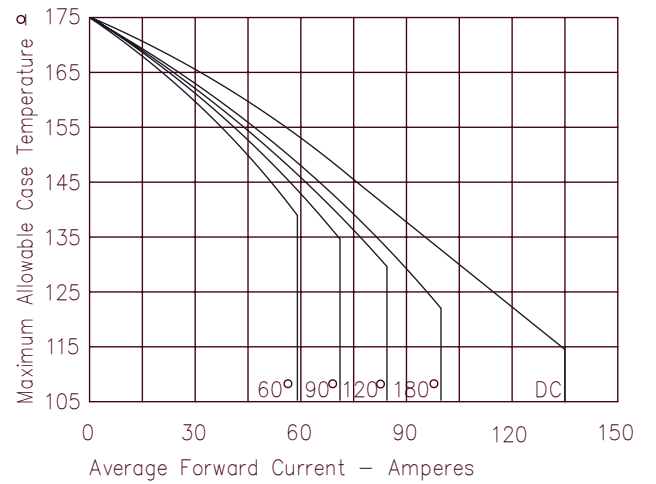


Figure 2  
Typical Reverse Characteristics – Per Leg

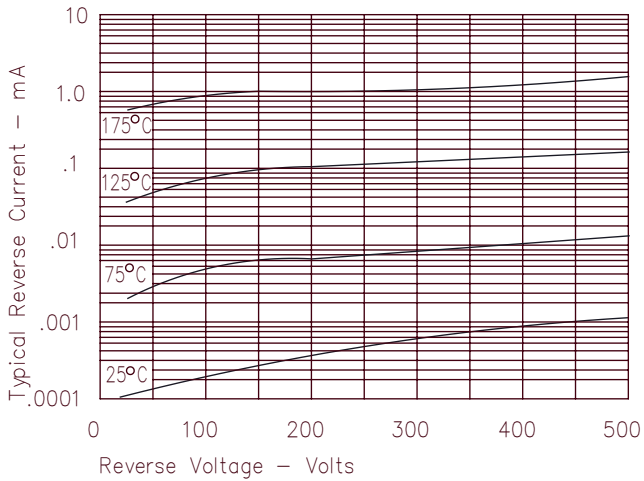
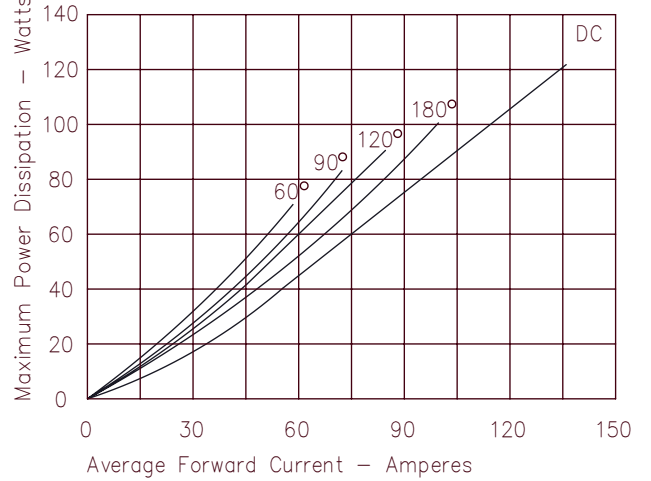


Figure 5  
Maximum Forward Power Dissipation – Per Leg



# UFT202

Figure 1  
Typical Forward Characteristics – Per Leg

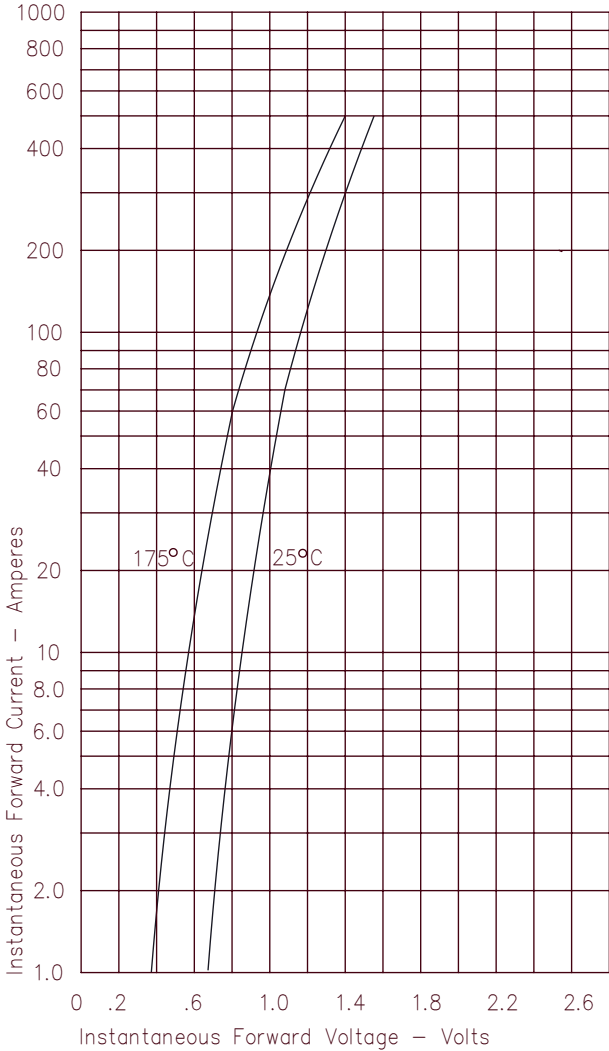


Figure 3  
Typical Junction Capacitance – Per Leg

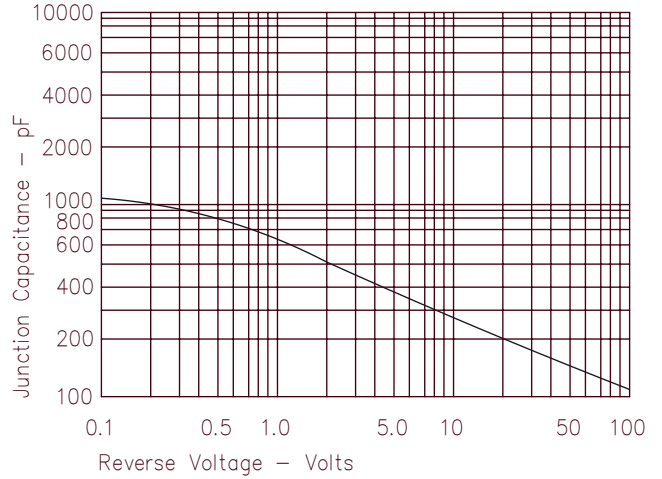


Figure 4  
Forward Current Derating – Per Leg

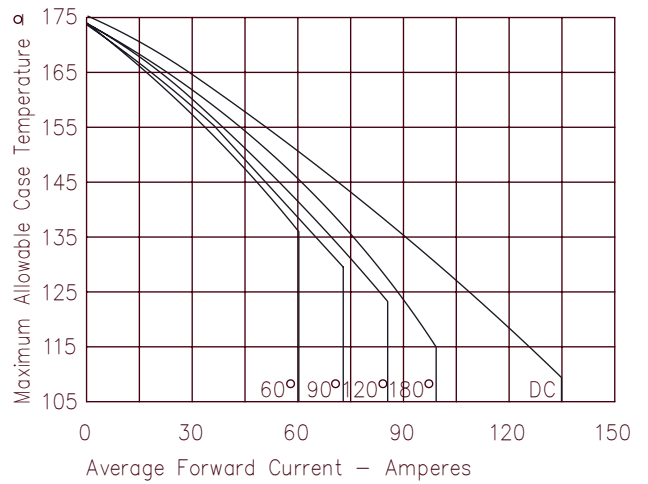


Figure 2  
Typical Reverse Characteristics – Per Leg

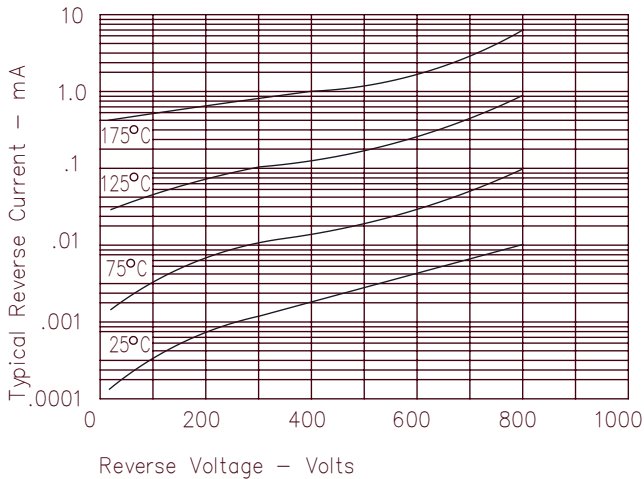
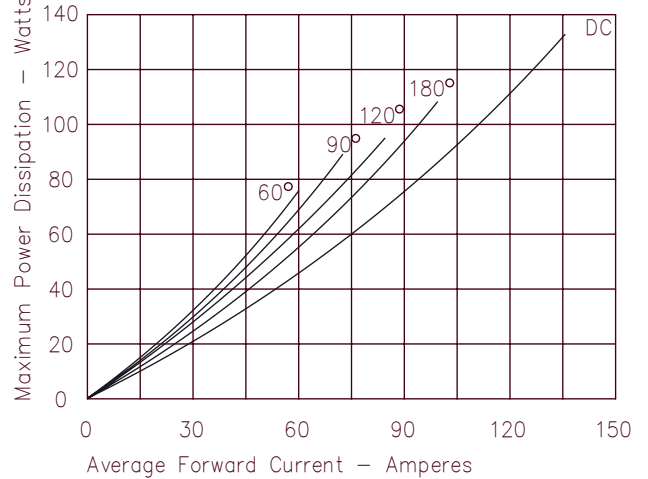


Figure 5  
Maximum Forward Power Dissipation – Per Leg



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